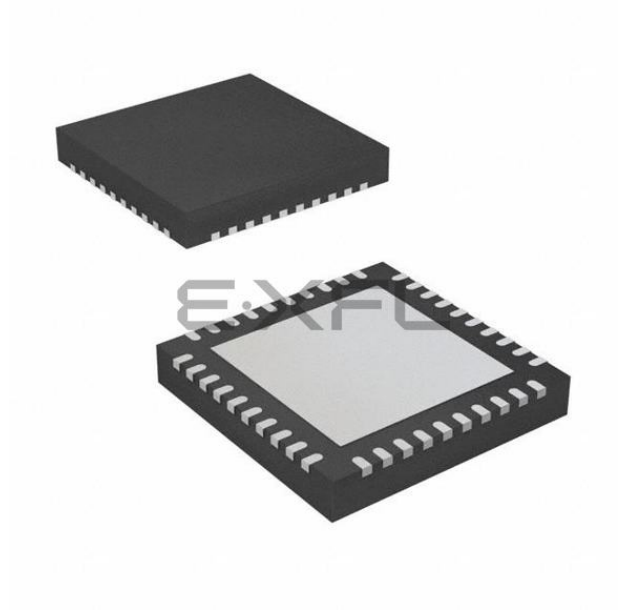


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PSMC, PWM, WDT
Number of I/O	35
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 14x12b; D/A 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UFQFN Exposed Pad
Supplier Device Package	40-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1787-i-mv

TABLE 3-12: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 2											
10Ch	LATA	PORTA Data Latch								xxxx xxxx	uuuu uuuu
10Dh	LATB	PORTB Data Latch								xxxx xxxx	uuuu uuuu
10Eh	LATC	PORTC Data Latch								xxxx xxxx	uuuu uuuu
10Fh	LATD(3)	PORTD Data Latch								xxxx xxxx	uuuu uuuu
110h	LATE(3)	—	—	—	—	—	LATE2	LATE1	LATE0	---- -111	---- -111
111h	CM1CON0	C1ON	C1OUT	C1OE	C1POL	C1ZLF	C1SP	C1HYS	C1SYNC	0000 0100	0000 0100
112h	CM1CON1	C1INTP	C1INTN	C1PCH<2:0>			C1NCH<2:0>			0000 0000	0000 0000
113h	CM2CON0	C2ON	C2OUT	C2OE	C2POL	C2ZLF	C2SP	C2HYS	C2SYNC	0000 0100	0000 0100
114h	CM2CON1	C2INTP	C2INTN	C2PCH<2:0>			C2NCH<2:0>			0000 0000	0000 0000
115h	CMOUT	—	—	—	—	MC4OUT(3)	MC3OUT	MC2OUT	MC1OUT	---- 0000	---- 0000
116h	BORCON	SBOREN	BORFS	—	—	—	—	—	BORRDY	1x-- ---q	uu-- ---u
117h	FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR<1:0>		ADFVR<1:0>		0q00 0000	0q00 0000
118h	DAC1CON0	DAC1EN	---	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		---	DAC1NSS	0-00 00-0	0-00 00-0
119h	DAC1CON1	DAC1R<7:0>								0000 0000	0000 0000
11Ah	CM4CON0	C4ON	C4OUT	C4OE	C4POL	C4ZLF	C4SP	C4HYS	C4SYNC	0000 0100	0000 0100
11Bh	CM4CON1	C4INTP	C4INTN	C4PCH<1:0>		—	—	C4NCH<1:0>		0000 --00	0000 --00
11Ch	APFCON2	—	—	—	—	—	—	—	CCP3SEL	---- ---0	---- ---0
11Dh	APFCON1	C2OUTSEL	CC1PSEL	SDOSEL	SCKSEL	SDISEL	TXSEL	RXSEL	CCP2SEL	0000 0000	0000 0000
11Eh	CM3CON0	C3ON	C3OUT	C3OE	C3POL	C3ZLF	C3SP	C3HYS	C3SYNC	0000 0100	0000 0100
11Fh	CM3CON1	C3INTP	C3INTN	C3PCH<2:0>			C3NCH<2:0>			0000 0000	0000 0000
Bank 3											
18Ch	ANSELA	ANSA7	—	ANSA5	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	1-11 1111	1-11 1111
18Dh	ANSELB	—	ANSB6	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	-111 1111	-111 1111
18Eh	Unimplemented								—	—	—
18Fh	ANSELD(3)	—	—	—	—	—	ANSD2	ANSD1	ANSD0	---- -111	---- -111
190h	ANSELE(3)	—	—	—	—	—	ANSE2	ANSE1	ANSE0	---- -111	---- -111
191h	EEADRL	EEPROM / Program Memory Address Register Low Byte								0000 0000	0000 0000
192h	EEADRH	—(2)	EEPROM / Program Memory Address Register High Byte							1000 0000	1000 0000
193h	EEDATL	EEPROM / Program Memory Read Data Register Low Byte								xxxx xxxx	uuuu uuuu
194h	EEDATH	—	—	EEPROM / Program Memory Read Data Register High Byte						--xx xxxx	--uu uuuu
195h	EECON1	EEPGD	CFGS	LWLO	FREE	WRERR	WREN	WR	RD	0000 x000	0000 q000
196h	EECON2	EEPROM / Program Memory Control Register 2								0000 0000	0000 0000
197h	VREGCON(4)	—	—	—	—	—	—	VREGPM	Reserved	---- --01	---- --01
198h	—	Unimplemented								—	—
199h	RCREG	EUSART Receive Data Register								0000 0000	0000 0000
19Ah	TXREG	EUSART Transmit Data Register								0000 0000	0000 0000
19Bh	SPBRG	BRG<7:0>								0000 0000	0000 0000
19Ch	SPBRGH	BRG<15:8>								0000 0000	0000 0000
19Dh	RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 0000	0000 0000
19Eh	TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	0000 0010
19Fh	BAUDCON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	01-0 0-00	01-0 0-00

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved.
Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from any bank.
2: Unimplemented, read as '1'.
3: PIC16(L)F1784/7 only.
4: PIC16F1784/6/7 only.

TABLE 3-12: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 31											
F8Ch to FE3h	—	Unimplemented								—	—
FE4h	STATUS_ SHAD	—	—	—	—	—	Z	DC	C	---- -xxx	---- -uuu
FE5h	WREG_SHAD	Working Register Shadow								xxxx xxxx	uuuu uuuu
FE6h	BSR_SHAD	—	—	—	Bank Select Register Shadow					---x xxxx	---u uuuu
FE7h	PCLATH_ SHAD	—	Program Counter Latch High Register Shadow							-xxx xxxx	uuuu uuuu
FE8h	FSR0L_SHAD	Indirect Data Memory Address 0 Low Pointer Shadow								xxxx xxxx	uuuu uuuu
FE9h	FSR0H_ SHAD	Indirect Data Memory Address 0 High Pointer Shadow								xxxx xxxx	uuuu uuuu
FEAh	FSR1L_SHAD	Indirect Data Memory Address 1 Low Pointer Shadow								xxxx xxxx	uuuu uuuu
FEBh	FSR1H_ SHAD	Indirect Data Memory Address 1 High Pointer Shadow								xxxx xxxx	uuuu uuuu
FECh	—	Unimplemented								—	—
FEDh	STKPTR	—	—	—	Current Stack Pointer					---1 1111	---1 1111
FEEh	TOSL	Top of Stack Low byte								xxxx xxxx	uuuu uuuu
FEFh	TOSH	—	Top of Stack High byte							-xxx xxxx	-uuu uuuu

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from any bank.

2: Unimplemented, read as '1'.

3: PIC16(L)F1784/7 only.

4: PIC16F1784/6/7 only.

REGISTER 8-7: PIR2: PERIPHERAL INTERRUPT REQUEST REGISTER 2

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
OSFIF	C2IF	C1IF	EEIF	BCL1IF	C4IF	C3IF	CCP2IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **OSFIF:** Oscillator Fail Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 6 **C2IF:** Comparator C2 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 5 **C1IF:** Comparator C1 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 4 **EEIF:** EEPROM Write Completion Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 3 **BCL1IF:** MSSP Bus Collision Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 2 **C4IF:** Comparator C4 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 1 **C3IF:** Comparator C3 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 0 **CCP2IF:** CCP2 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

TABLE 11-3: SUMMARY OF REGISTERS ASSOCIATED WITH WATCHDOG TIMER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON	SPLLEN	IRCF<3:0>				—	SCS<1:0>		82
STATUS	—	—	—	$\overline{TO}$	$\overline{PD}$	Z	DC	C	27
WDTCON	—	—	WDTPS<4:0>					SWDTEN	110

Legend: x = unknown, u = unchanged, – = unimplemented locations read as '0'. Shaded cells are not used by Watchdog Timer.

TABLE 11-4: SUMMARY OF CONFIGURATION WORD WITH WATCHDOG TIMER

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	FCMEN	IESO	$\overline{CLKOUTEN}$	BOREN<1:0>		$\overline{CPD}$	54
	7:0	$\overline{CP}$	MCLRE	$\overline{PWRTE}$	WDTE<1:0>		FOSC<2:0>			

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by Watchdog Timer.

REGISTER 13-8: ODCONA: PORTA OPEN DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODA7	ODA6	ODA5	ODA4	ODA3	ODA2	ODA1	ODA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ODA<7:0>:** PORTA Open Drain Enable bits
For RA<7:0> pins, respectively
1 = Port pin operates as open-drain drive (sink current only)
0 = Port pin operates as standard push-pull drive (source and sink current)

REGISTER 13-9: SLRCONA: PORTA SLEW RATE CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
SLRA7	SLRA6	SLRA5	SLRA4	SLRA3	SLRA2	SLRA1	SLRA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **SLRA<7:0>:** PORTA Slew Rate Enable bits
For RA<7:0> pins, respectively
1 = Port pin slew rate is limited
0 = Port pin slews at maximum rate

REGISTER 13-10: INLVLA: PORTA INPUT LEVEL CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
INLVLA7	INLVLA6	INLVLA5	INLVLA4	INLVLA3	INLVLA2	INLVLA1	INLVLA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **INLVLA<7:0>:** PORTA Input Level Select bits
For RA<7:0> pins, respectively
1 = ST input used for PORT reads and interrupt-on-change
0 = TTL input used for PORT reads and interrupt-on-change

REGISTER 13-22: WPUC: WEAK PULL-UP PORTC REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
WPUC7	WPUC6	WPUC5	WPUC4	WPUC3	WPUC2	WPUC1	WPUC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **WPUC<7:0>**: Weak Pull-up Register bits
1 = Pull-up enabled
0 = Pull-up disabled

Note 1: Global $\overline{\text{WPUEN}}$ bit of the OPTION_REG register must be cleared for individual pull-ups to be enabled.
2: The weak pull-up device is automatically disabled if the pin is in configured as an output.

REGISTER 13-23: ODCONC: PORTC OPEN DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODC7	ODC6	ODC5	ODC4	ODC3	ODC2	ODC1	ODC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ODC<7:0>:** PORTC Open Drain Enable bits
For RC<7:0> pins, respectively
1 = Port pin operates as open-drain drive (sink current only)
0 = Port pin operates as standard push-pull drive (source and sink current)

REGISTER 13-24: SLRCONC: PORTC SLEW RATE CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
SLRC7	SLRC6	SLRC5	SLRC4	SLRC3	SLRC2	SLRC1	SLRC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **SLRC<7:0>:** PORTC Slew Rate Enable bits
For RC<7:0> pins, respectively
1 = Port pin slew rate is limited
0 = Port pin slews at maximum rate

REGISTER 13-25: INLVLC: PORTC INPUT LEVEL CONTROL REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
INLVLC7	INLVLC6	INLVLC5	INLVLC4	INLVLC3	INLVLC2	INLVLC1	INLVLC0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **INLVLC<7:0>:** PORTC Input Level Select bits
For RC<7:0> pins, respectively
1 = ST input used for PORT reads and interrupt-on-change
0 = TTL input used for PORT reads and interrupt-on-change

TABLE 13-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	142
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	142
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	142
WPUC	WPUC7	WPUC6	WPUC5	WPUC4	WPUC3	WPUC2	WPUC1	WPUC0	143
INLVLC	INLVLC7	INLVLC6	INLVLC5	INLVLC4	INLVLC3	INLVLC2	INLVLC1	INLVLC0	144
LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	142
ODCONC	ODC7	ODC6	ODC5	ODC4	ODC3	ODC2	ODC1	ODC0	143
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	142
SLRCONC	SLRC7	SLRC6	SLRC5	SLRC4	SLRC3	SLRC2	SLRC1	SLRC0	143

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTC.

17.1 ADC Configuration

When configuring and using the ADC the following functions must be considered:

- Port configuration
- Channel selection
  - Single-ended
  - Differential
- ADC voltage reference selection
- ADC conversion clock source
- Interrupt control
- Result formatting

17.1.1 PORT CONFIGURATION

The ADC can be used to convert both analog and digital signals. When converting analog signals, the I/O pin should be configured for analog by setting the associated TRIS and ANSEL bits. Refer to **Section 13.0 "I/O Ports"** for more information.

Note:	Analog voltages on any pin that is defined as a digital input may cause the input buffer to conduct excess current.

17.1.2 CHANNEL SELECTION

There are up to 18 channel selections available:

- AN<13:8, 4:0> pins (PIC16(L)F1786 only)
- AN<21, 13:0> pins (PIC16(L)F1784/7 only)
- Temperature Indicator
- DAC_output
- FVR (Fixed Voltage Reference) Output

Refer to **Section 15.0 "Fixed Voltage Reference (FVR)"** and **Section 16.0 "Temperature Indicator Module"** for more information on these channel selections.

When converting differential signals, the negative input for the channel is selected with the CHSN<3:0> bits of the ADCON2 register. Any positive input can be paired with any negative input to determine the differential channel.

The CHS<4:0> bits of the ADCON0 register determine which positive channel is selected.

When CHSN<3:0> = 1111 then the ADC is effectively a single ended ADC converter.

When changing channels, a delay is required before starting the next conversion.

17.1.3 ADC VOLTAGE REFERENCE

The ADPREF bits of the ADCON1 register provide control of the positive voltage reference. The positive voltage reference can be:

- V_{REF+}
- V_{DD}
- FVR Buffer1

The ADNREF bits of the ADCON1 register provide control of the negative voltage reference. The negative voltage reference can be:

- V_{REF-} pin
- V_{SS}

See **Section 15.0 "Fixed Voltage Reference (FVR)"** for more details on the Fixed Voltage Reference.

17.1.4 CONVERSION CLOCK

The source of the conversion clock is software selectable via the ADCS bits of the ADCON1 register. There are seven possible clock options:

- $F_{OSC}/2$
- $F_{OSC}/4$
- $F_{OSC}/8$
- $F_{OSC}/16$
- $F_{OSC}/32$
- $F_{OSC}/64$
- F_{RC} (dedicated internal F_{RC} oscillator)

The time to complete one bit conversion is defined as T_{AD}. One full 12-bit conversion requires 15 T_{AD} periods as shown in Figure 17-2.

For correct conversion, the appropriate T_{AD} specification must be met. Refer to the ADC conversion requirements in **Section 30.0 "Electrical Specifications"** for more information. Table 17-1 gives examples of appropriate ADC clock selections.

Note:	Unless using the F_{RC}, any changes in the system clock frequency will change the ADC clock frequency, which may adversely affect the ADC result.

19.0 DIGITAL-TO-ANALOG CONVERTER (DAC) MODULE

The Digital-to-Analog Converter supplies a variable voltage reference, ratiometric with the input source, with 256 selectable output levels.

The input of the DAC can be connected to:

- External VREF pins
- VDD supply voltage
- FVR (Fixed Voltage Reference)

The output of the DAC can be configured to supply a reference voltage to the following:

- Comparator positive input
- OpAmp positive input
- ADC input channel
- DAC1OUT1 pin
- DAC1OUT2 pin

The Digital-to-Analog Converter (DAC) is enabled by setting the DAC1EN bit of the DAC1CON0 register.

19.1 Output Voltage Selection

The DAC has 256 voltage level ranges. The 256 levels are set with the DAC1R<7:0> bits of the DAC1CON1 register.

The DAC output voltage is determined by Equation 19-1:

EQUATION 19-1: DAC OUTPUT VOLTAGE

IF DACxEN = 1

$$V_{OUT} = \left((V_{SOURCE+} - V_{SOURCE-}) \times \frac{DACxR[7:0]}{2^8} \right) + V_{SOURCE-}$$

VSOURCE+ = VDD, VREF, or FVR BUFFER 2

VSOURCE- = VSS

19.2 Ratiometric Output Level

The DAC output value is derived using a resistor ladder with each end of the ladder tied to a positive and negative voltage reference input source. If the voltage of either input source fluctuates, a similar fluctuation will result in the DAC output value.

The value of the individual resistors within the ladder can be found in **Section 30.0 "Electrical Specifications"**.

19.3 DAC Voltage Reference Output

The DAC voltage can be output to the DAC1OUT1 and DAC1OUT2 pins by setting the respective DAC1OE1 and DAC1OE2 pins of the DAC1CON0 register. Selecting the DAC reference voltage for output on either DAC1OUTx pin automatically overrides the digital output buffer and digital input threshold detector functions of that pin. Reading the DAC1OUTx pin when it has been configured for DAC reference voltage output will always return a '0'.

Due to the limited current drive capability, a buffer must be used on the DAC voltage reference output for external connections to either DAC1OUTx pin. Figure 19-2 shows an example buffering technique.

19.6 Register Definitions: DAC Control

REGISTER 19-1: DAC1CON0: VOLTAGE REFERENCE CONTROL REGISTER 0

R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0
DAC1EN	—	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		—	DAC1NSS
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **DAC1EN:** DAC1 Enable bit
1 = DAC1 is enabled
0 = DAC1 is disabled

bit 6 **Unimplemented:** Read as ‘0’

bit 5 **DAC1OE1:** DAC1 Voltage Output 1 Enable bit
1 = DAC1 voltage level is also an output on the DAC1OUT1 pin
0 = DAC1 voltage level is disconnected from the DAC1OUT1 pin

bit 4 **DAC1OE2:** DAC1 Voltage Output 2 Enable bit
1 = DAC1 voltage level is also an output on the DAC1OUT2 pin
0 = DAC1 voltage level is disconnected from the DAC1OUT2 pin

bit 3-2 **DAC1PSS<1:0>:** DAC1 Positive Source Select bits
11 = Reserved, do not use
10 = FVR Buffer2 output
01 = V_{REF+} pin
00 = V_{DD}

bit 1 **Unimplemented:** Read as ‘0’

bit 0 **DAC1NSS:** DAC1 Negative Source Select bits
1 = V_{REF-} pin
0 = V_{SS}

REGISTER 19-2: DAC1CON1: VOLTAGE REFERENCE CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
DAC1R<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **DAC1R<7:0>:** DAC1 Voltage Output Select bits

TABLE 19-1: SUMMARY OF REGISTERS ASSOCIATED WITH THE DAC MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR<1:0>		ADFVR<1:0>		**162**
DAC1CON0	DAC1EN	—	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		—	DAC1NSS	**186**
DAC1CON1	DAC1R<7:0>								**186**

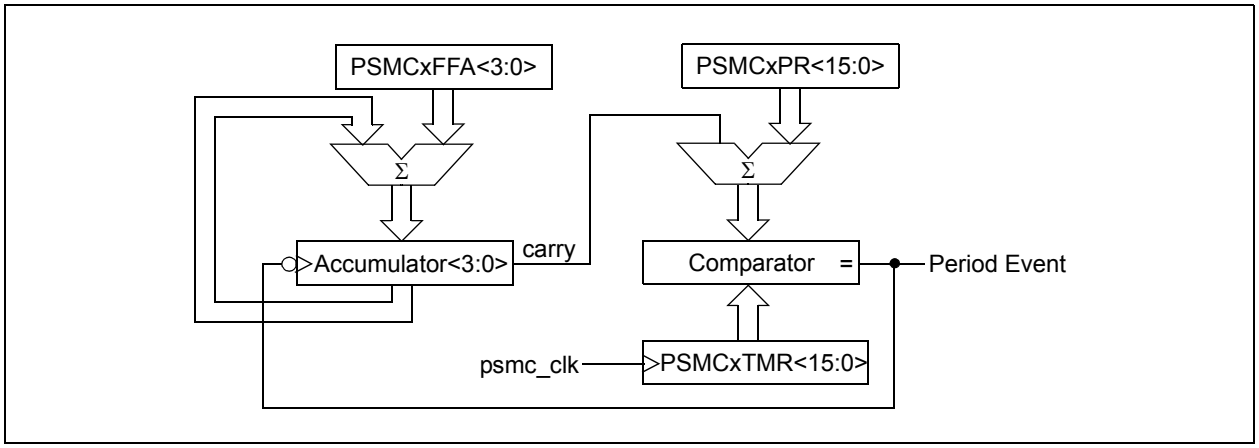
Legend: — = Unimplemented location, read as ‘0’. Shaded cells are not used with the DAC module.

24.9 Fractional Frequency Adjust (FFA)

FFA is a method by which PWM resolution can be improved on 50% fixed duty cycle signals. Higher resolution is achieved by altering the PWM period by a single count for calculated intervals. This increased resolution is based upon the PWM frequency averaged over a large number of PWM periods. For example, if the period event time is increased by one psmc_clk period (TPSMC_CLK) every N events, then the effective resolution of the average event period is TPSMC_CLK/N.

When active, after every period event the FFA hardware adds the PSMCxFFA value with the previously accumulated result. Each time the addition causes an overflow, the period event time is increased by one. Refer to Figure 24-22.

FIGURE 24-22: FFA BLOCK DIAGRAM.



The FFA function is only available when using one of the two Fixed Duty Cycle modes of operation. In fixed duty cycle operation each PWM period is comprised of two period events. That is why the PWM periods in Table 24-3 example calculations are multiplied by two as opposed to the normal period calculations for normal mode operation.

The extra resolution gained by the FFA is based upon the number of bits in the FFA register and the psmc_clk frequency. The parameters of interest are:

- TPWM – this is the lower bound of the PWM period that will be adjusted
- TPWM+1 – this is the upper bound of the PWM period that will be adjusted. This is used to help determine the step size for each increment of the FFA register
- TRESOLUTION – each increment of the FFA register will add this amount of period to average PWM frequency

TABLE 24-3: FRACTIONAL FREQUENCY ADJUST CALCULATIONS

Parameter	Value
FPSMC_CLK	64 MHz
TPSMC_CLK	15.625 ns
PSMCxPR<15:0>	00FFh = 255
TPWM	= (PSMCxPR<15:0>+1)*2*TPSMC_CLK = 256*2*15.625ns = 8 us
FPWM	125 kHz
TPWM+1	= (PSMCxPR<15:0>+2)*2*TPSMC_CLK = 257*2*15.625ns = 8.03125 us
FPWM+1	= 124.513 kHz
TRESOLUTION	= (TPWM+1-TPWM)/$2^{FFA\text{-}Bits}$ = (8.03125us - 8.0 us)/16 = 0.03125us/16 ~ 1.95 ns
FRESOLUTION	(FPWM+1-FPWM)/$2^{FFA\text{-}Bits}$ ~ -30.4 Hz

REGISTER 24-17: PSMCxASDS: PSMC AUTO-SHUTDOWN SOURCE REGISTER

R/W-0/0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0
PxASDSIN	—	—	PxASDSC4	PxASDSC3	PxASDSC2	PxASDSC1	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **PxASDSIN:** Auto-shutdown occurs on PSMCxIN pin
1 = Auto-shutdown will occur when PSMCxIN pin goes true
0 = PSMCxIN pin will not cause auto-shutdown

bit 6-5 **Unimplemented:** Read as '0'

bit 4 **PxASDSC4:** Auto-shutdown occurs on sync_C4OUT output
1 = Auto-shutdown will occur when sync_C4OUT output goes true
0 = sync_C4OUT will not cause auto-shutdown

bit 3 **PxASDSC3:** Auto-shutdown occurs on sync_C3OUT output
1 = Auto-shutdown will occur when sync_C3OUT output goes true
0 = sync_C3OUT will not cause auto-shutdown

bit 2 **PxASDSC2:** Auto-shutdown occurs on sync_C2OUT output
1 = Auto-shutdown will occur when sync_C2OUT output goes true
0 = sync_C2OUT will not cause auto-shutdown

bit 1 **PxASDSC1:** Auto-shutdown occurs on sync_C1OUT output
1 = Auto-shutdown will occur when sync_C1OU output goes true
0 = sync_C1OU will not cause auto-shutdown

bit 0 **Unimplemented:** Read as '0'

FIGURE 26-9: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

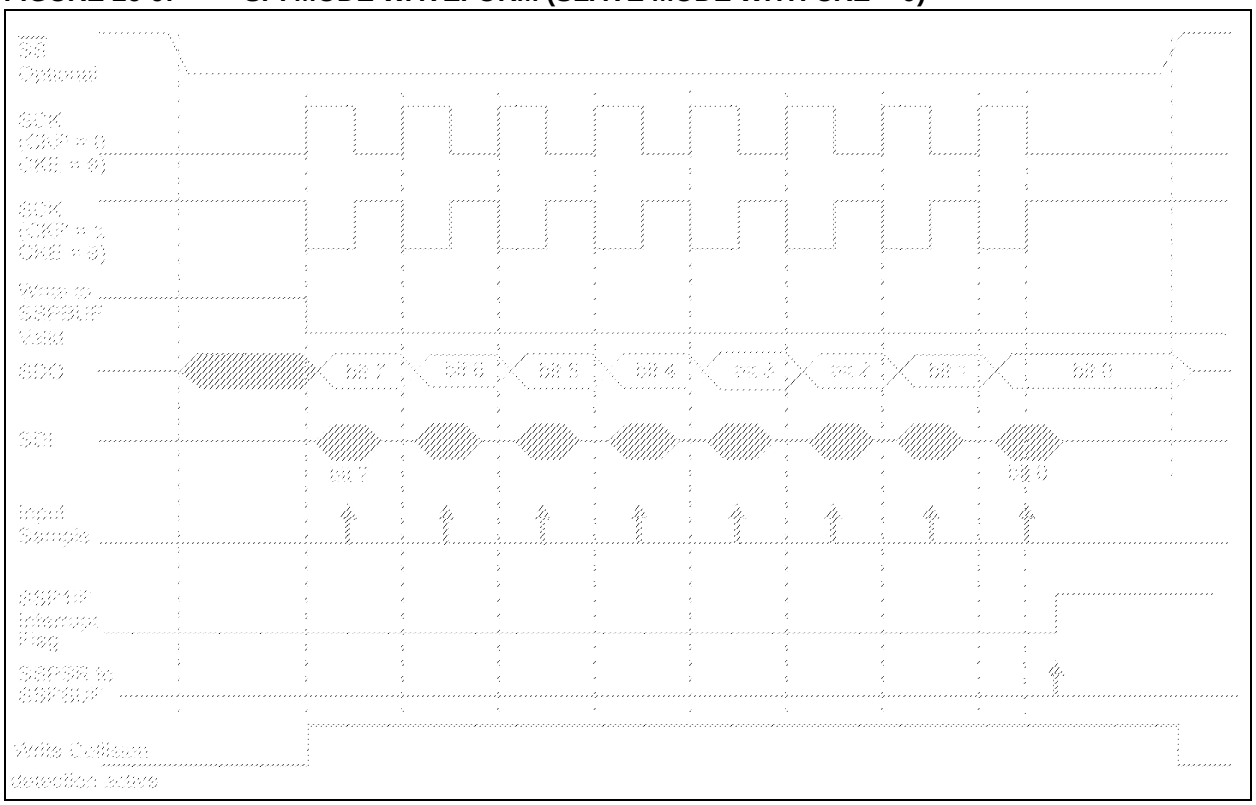


FIGURE 26-10: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 1)

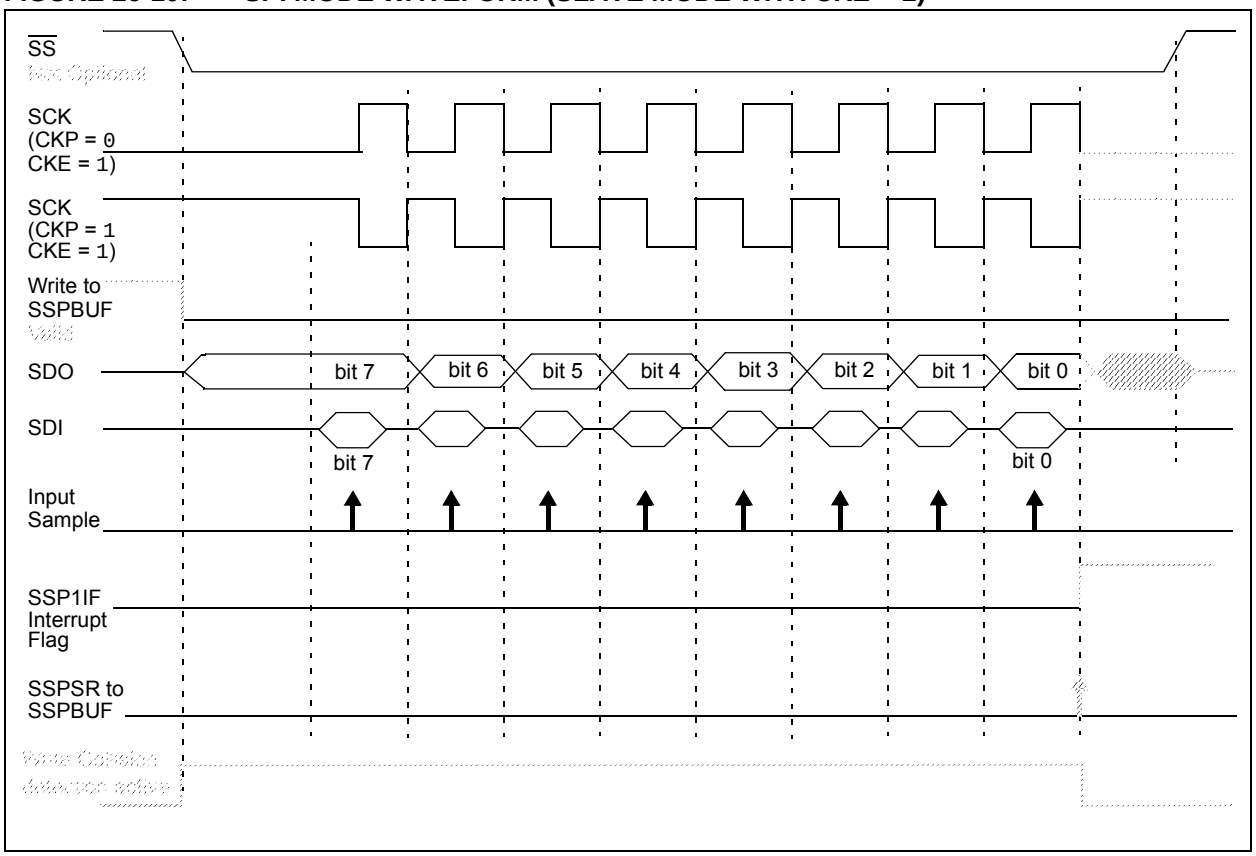
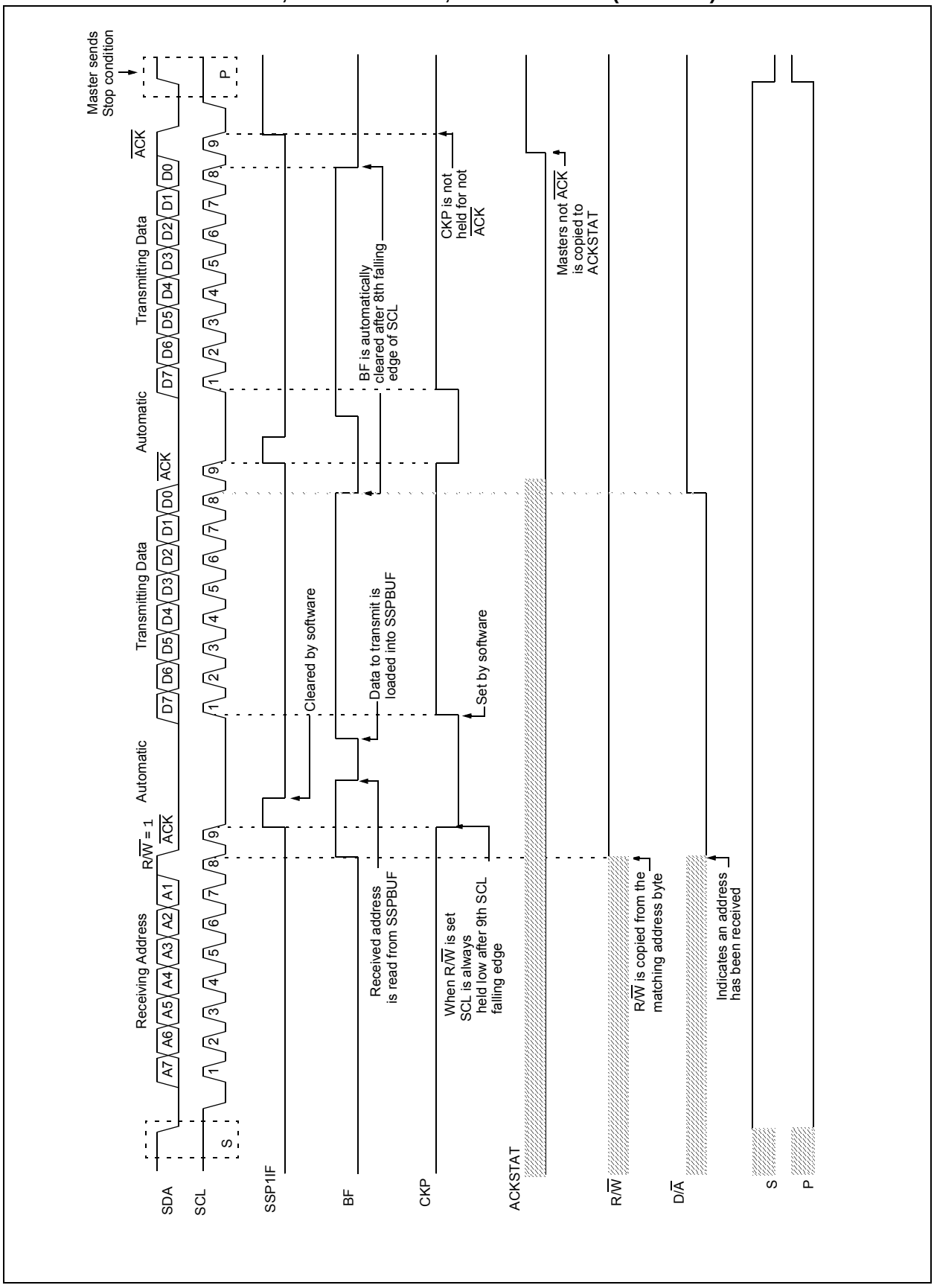


FIGURE 26-18: I²C SLAVE, 7-BIT ADDRESS, TRANSMISSION (AHEN = 0)



26.6 I²C Master Mode

Master mode is enabled by setting and clearing the appropriate SSPM bits in the SSPCON1 register and by setting the SSPEN bit. In Master mode, the SDA and SCK pins must be configured as inputs. The MSSP peripheral hardware will override the output driver TRIS controls when necessary to drive the pins low.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit is set, or the bus is Idle.

In Firmware Controlled Master mode, user code conducts all I²C bus operations based on Start and Stop bit condition detection. Start and Stop condition detection is the only active circuitry in this mode. All other communication is done by the user software directly manipulating the SDA and SCL lines.

The following events will cause the SSP Interrupt Flag bit, SSP1IF, to be set (SSP interrupt, if enabled):

- Start condition detected
- Stop condition detected
- Data transfer byte transmitted/received
- Acknowledge transmitted/received
- Repeated Start generated

Note 1: The MSSP module, when configured in I²C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSPBUF register to initiate transmission before the Start condition is complete. In this case, the SSPBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPBUF did not occur

2: When in Master mode, Start/Stop detection is masked and an interrupt is generated when the SEN/PEN bit is cleared and the generation is complete.

26.6.1 I²C MASTER MODE OPERATION

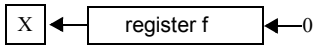
The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/$\overline{W}$) bit. In this case, the R/$\overline{W}$ bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

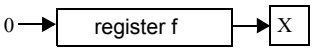
In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/$\overline{W}$ bit. In this case, the R/$\overline{W}$ bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

A Baud Rate Generator is used to set the clock frequency output on SCL. See **Section 26.7 "Baud Rate Generator"** for more detail.

LSLF	Logical Left Shift
Syntax:	[*label*] LSLF f {,d}
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f<7>) → C (f<6:0>) → dest<7:1> 0 → dest<0>
Status Affected:	C, Z
Description:	The contents of register 'f' are shifted one bit to the left through the Carry flag. A '0' is shifted into the LSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



LSRF	Logical Right Shift
Syntax:	[*label*] LSRF f {,d}
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	0 → dest<7> (f<7:1>) → dest<6:0>, (f<0>) → C,
Status Affected:	C, Z
Description:	The contents of register 'f' are shifted one bit to the right through the Carry flag. A '0' is shifted into the MSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



MOVF	Move f
Syntax:	[*label*] MOVF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f) → (dest)
Status Affected:	Z
Description:	The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.
Words:	1
Cycles:	1
Example:	`MOVF FSR, 0` After Instruction W = value in FSR register Z = 1

TABLE 30-3: POWER-DOWN CURRENTS (I_{PD})(1,2,4) (CONTINUED)

PIC16LF1784/6/7		Operating Conditions: (unless otherwise stated) Low-Power Sleep Mode						
PIC16F1784/6/7		Low-Power Sleep Mode, VREGPM = 1						
Param No.	Device Characteristics	Min.	Typ†	Max. +85°C	Max. +125°C	Units	Conditions	
							V_{DD}	Note
	Power-down Base Current (I_{PD})(2)							
D029		—	0.05	2	9	μA	1.8	ADC Current **(Note 3)**, no conversion in progress
		—	0.08	3	10	μA	3.0	
D029		—	0.3	4	12	μA	2.3	ADC Current **(Note 3)**, no conversion in progress
		—	0.4	5	13	μA	3.0	
		—	0.5	7	16	μA	5.0	
D030		—	250	—	—	μA	1.8	ADC Current **(Note 3)**, conversion in progress
		—	280	—	—	μA	3.0	
D030		—	230	—	—	μA	2.3	ADC Current **(Note 3, Note 4, Note 5)**, conversion in progress
		—	250	—	—	μA	3.0	
		—	350	—	—	μA	5.0	
D031		—	250	650	—	μA	3.0	Op Amp (High power)
D031			250	650	—	μA	3.0	Op Amp (High power) **(Note 5)**
		—	350	850	—	μA	5.0	
D032		—	250	650	—	μA	1.8	Comparator, Normal-Power mode
		—	300	700	—	μA	3.0	
D032		—	280	650	—	μA	2.3	Comparator, Normal-Power mode **(Note 5)**
		—	300	700	—	μA	3.0	
		—	310	700	—	μA	5.0	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The peripheral current is the sum of the base I_{PD} and the additional current consumed when this peripheral is enabled. The peripheral Δ current can be determined by subtracting the base I_{DD} or I_{PD} current from this limit. Max values should be used when calculating total current consumption.

2: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to V_{SS}.

3: ADC oscillator source is FRC.

4: 0.1 μF capacitor on V_{CAP}.

5: VREGPM = 0.

Note: Unless otherwise noted, VIN = 5V, FOSC = 300 kHz, CIN = 0.1 µF, TA = 25°C.

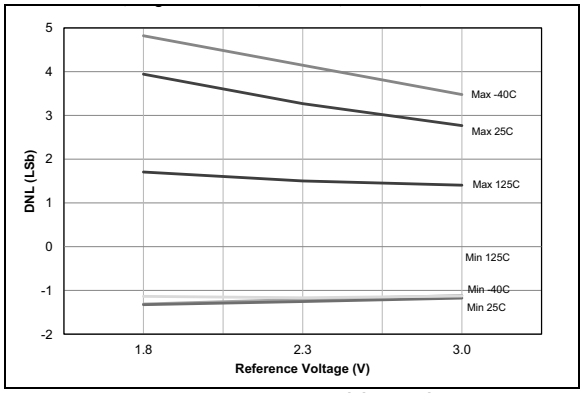


FIGURE 31-91: *ADC 12-bit Mode, Single-Ended DNL, VDD = 3.0V, TAD = 1 µS.*

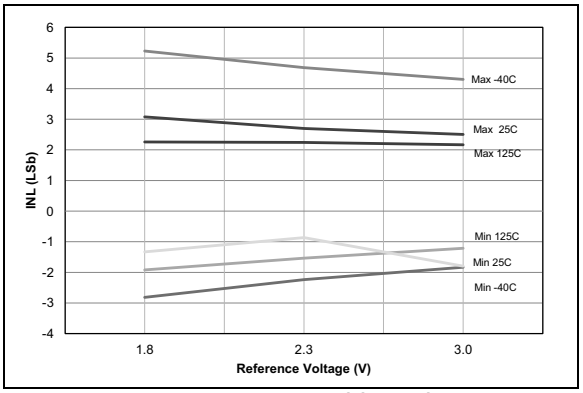


FIGURE 31-92: *ADC 12-bit Mode, Single-Ended INL, VDD = 3.0V, TAD = 1 µS.*

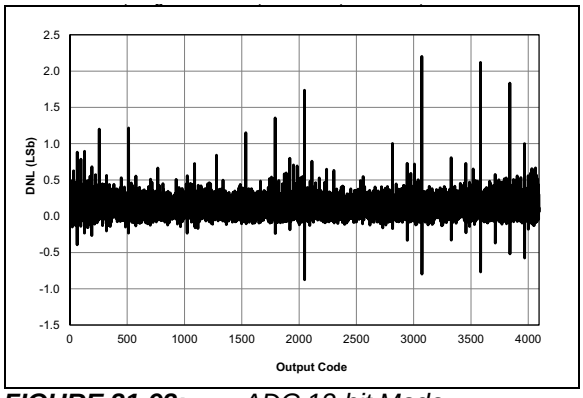


FIGURE 31-93: *ADC 12-bit Mode, Single-Ended DNL, VDD = 5.5V, TAD = 1 µS, 25°C.*

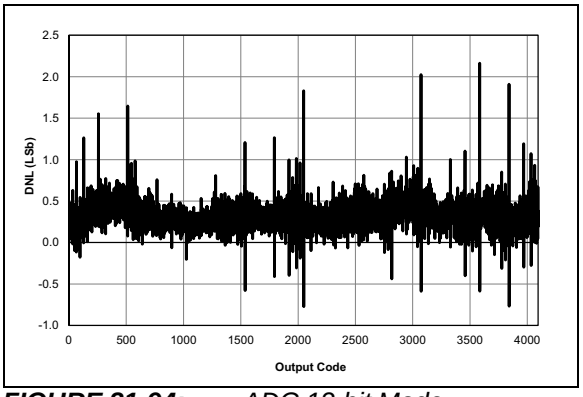


FIGURE 31-94: *ADC 12-bit Mode, Single-Ended DNL, VDD = 5.5V, TAD = 4 µS, 25°C.*

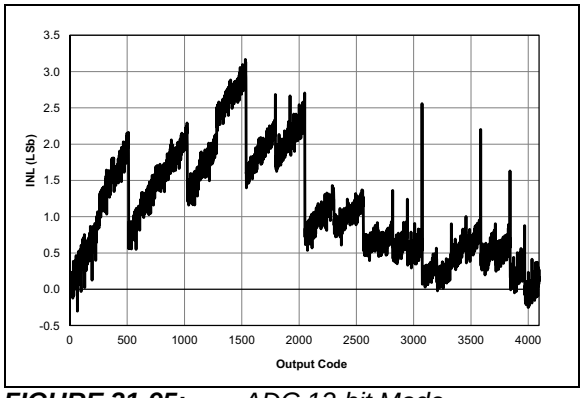


FIGURE 31-95: *ADC 12-bit Mode, Single-Ended INL, VDD = 5.5V, TAD = 1 µS, 25°C.*

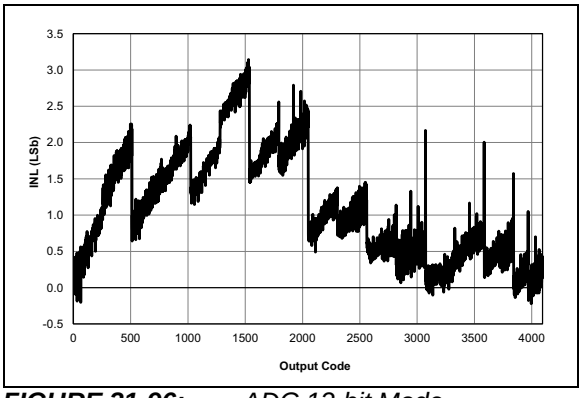
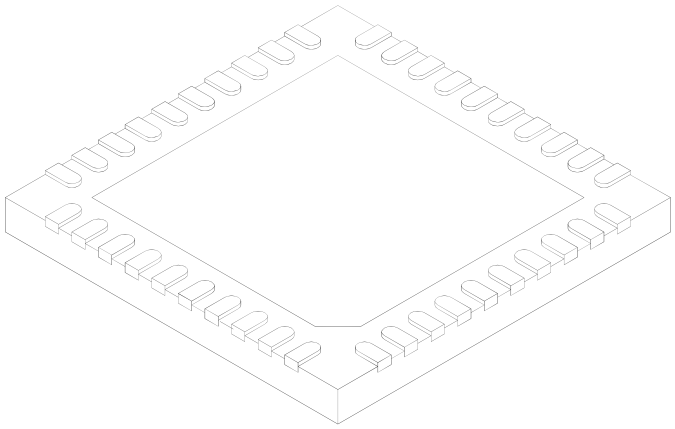


FIGURE 31-96: *ADC 12-bit Mode, Single-Ended INL, VDD = 5.5V, TAD = 4 µS, 25°C.*

40-Lead Ultra Thin Plastic Quad Flat, No Lead Package (MV) – 5x5x0.5 mm Body [UQFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		40	
Pitch	e		0.40 BSC	
Overall Height	A	0.45	0.50	0.55
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.127 REF	
Overall Width	E		5.00 BSC	
Exposed Pad Width	E2	3.60	3.70	3.80
Overall Length	D		5.00 BSC	
Exposed Pad Length	D2	3.60	3.70	3.80
Contact Width	b	0.15	0.20	0.25
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

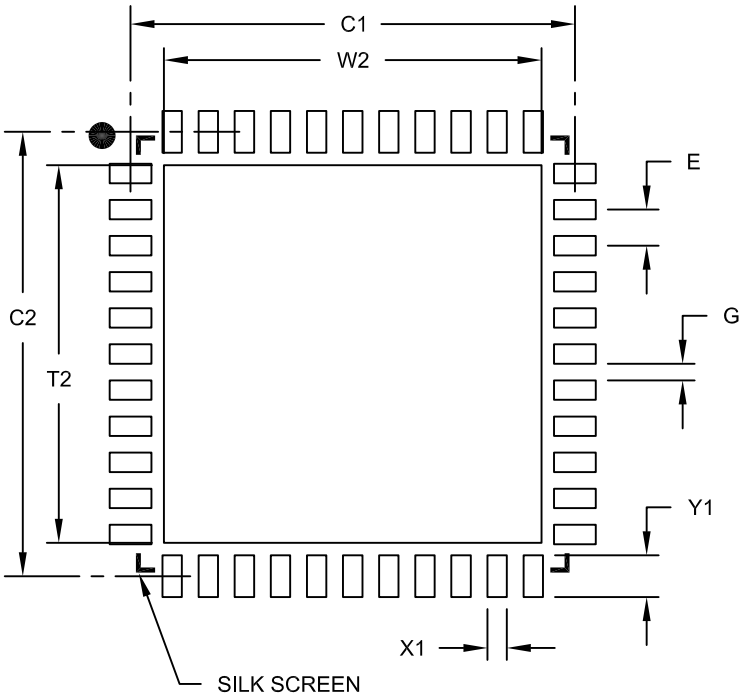
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-156A Sheet 2 of 2

44-Lead Plastic Quad Flat, No Lead Package (ML) - 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			6.60
Optional Center Pad Length	T2			6.60
Contact Pad Spacing	C1		8.00	
Contact Pad Spacing	C2		8.00	
Contact Pad Width (X44)	X1			0.35
Contact Pad Length (X44)	Y1			0.85
Distance Between Pads	G	0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2103B